

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																		
NATURE OF CONVEYANCE:	ASSIGNMENT																		
CONVEYING PARTY DATA																			
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr><td>Akihiko KAINO</td><td>04/15/2008</td></tr> <tr><td>Takashi HORISHI</td><td>04/15/2008</td></tr> <tr><td>Yukihiro NAKAMURA</td><td>04/22/2008</td></tr> <tr><td>Kunio KAWAGUCHI</td><td>04/15/2008</td></tr> <tr><td>Yasuaki TAKAHASHI</td><td>04/15/2008</td></tr> <tr><td>Norifumi YOSHIWARA</td><td>04/15/2008</td></tr> <tr><td>Takafumi MORIFUJI</td><td>04/15/2008</td></tr> <tr><td>Yuta CHOKI</td><td>04/16/2008</td></tr> </tbody> </table>		Name	Execution Date	Akihiko KAINO	04/15/2008	Takashi HORISHI	04/15/2008	Yukihiro NAKAMURA	04/22/2008	Kunio KAWAGUCHI	04/15/2008	Yasuaki TAKAHASHI	04/15/2008	Norifumi YOSHIWARA	04/15/2008	Takafumi MORIFUJI	04/15/2008	Yuta CHOKI	04/16/2008
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Yuta CHOKI	04/16/2008																		
RECEIVING PARTY DATA																			
Name:	Sony Corporation																		
Street Address:	1-7-1 Konan, Minato-Ku																		
City:	Tokyo																		
State/Country:	JAPAN																		
Postal Code:	108-0075																		
PROPERTY NUMBERS Total: 1																			
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12066091</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12066091														
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CORRESPONDENCE DATA																			
Fax Number:	(703)413-2220																		
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>																			
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ATTORNEY DOCKET NUMBER:	322443US8PCT																		

OP \$40.00 12066091

PATENT

500526138

REEL: 020872 FRAME: 0314

NAME OF SUBMITTER:

Chai Xiong

Total Attachments: 3

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ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in IMAGE PROCESSING DEVICE AND METHOD, PROGRAM, AND RECORDING MEDIUM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-Ku, Tokyo, 108-0075 Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 12/066,091
Filing Date: March 7, 2008

This assignment executed on the dates indicated below.

Akihiko KAINO

Name of first or sole inventor

Execution date of U.S. Patent Application

Kanagawa, Japan

Residence of first or sole inventor

Akihiko Kaino

Signature of first or sole inventor

April 15, 2008

Date of this assignment

Takashi HORISHI

Name of second inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of second inventor

Takashi Horishi
Signature of second inventor

April 15, 2008
Date of this assignment

Yukihiro NAKAMURA

Name of third inventor

Execution date of U.S. Patent Application

Kanagawa, Japan

Residence of third inventor

Yukihiro Nakamura
Signature of third inventor

April 22, 2008
Date of this assignment

Kunio KAWAGUCHI

Name of fourth inventor

Execution date of U.S. Patent Application

Kanagawa, Japan

Residence of fourth inventor

Kunio Kawaguchi
Signature of fourth inventor

April 15, 2008
Date of this assignment

Yasuaki TAKAHASHI

Name of fifth inventor

Execution date of U.S. Patent Application

Kanagawa, Japan

Residence of fifth inventor

Yasuaki Takahashi
Signature of fifth inventor

April 15, 2008
Date of this assignment

Norifumi YOSHIWARA

Name of sixth inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of sixth inventor

Norifumi Yoshiwara
Signature of sixth inventor

April 15, 2008
Date of this assignment

Takafumi MORIFUJI

Name of seventh inventor

Execution date of U.S. Patent Application

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Residence of seventh inventor

Takafumi Morifuji
Signature of seventh inventor

April 15, 2008
Date of this assignment

Yuta CHOKI

Name of eighth inventor

Execution date of U.S. Patent Application

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Residence of eighth inventor

Yuta Choki

April 16, 2008

Signature of eighth inventor

Date of this assignment